



DFLS160Q

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

POWERDI[®]123

Product Summary

V _R (V)	I _F (A)	V _{F MAX} (V) @ +25°C	I _{R MAX} (mA) @ +25°С
60	1.0	0.50	0.1

Description and Applications

This Schottky Barrier Rectifier has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as:

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (See Note 4)

Mechanical Data

- Case: POWERDI[®]123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202 Method 208 (3)
- Weight: 0.01 grams (approximate)



Top View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
DFLS160Q-7	Automotive	POWERDI [®] 123	3000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

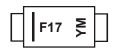
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



F17 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code	Key			_										
Year	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027
Code	В	С	D	E	F	G	Н		J	К	L	М	Ν	0
Month	lan	Feb	M	or	Anr	May	lun	1.1	Aug	50	<u>n</u> (Oct	Nov	Dec
wonth	Jan	гер	IVI	ar	Apr	way	Jun	Jul	Aug	Se	p (JCL	NOV	Dec
Code	1	2	0	3	4	5	6	7	8	9		0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

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For capacitance load	derate current by 20%.	
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Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	V
RMS Reverse Voltage	V _{R(RMS)}	42	V
Average Forward Current	I _{F(AV)}	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point (Note 6)	R _{0JS}	_	6	°C/W
Thermal Resistance Junction to Ambient (Note 7)	R _{0JA}	125	—	°C/W
Typical Thermal Resistance (Note 9)	R _{0JC}	_	18	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to	+150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 10)	V _{(BR)R}	60	_	—	V	I _R = 0.2mA
Forward Voltage	VF	_		0.50	V	I _F = 1.0A
Leakage Current (Note 10)	IR	_	_	0.1	mA	V _R = 60V, T _A = +25°C
Total Capacitance	CT		67		pF	V _R = 10V, f = 1.0MHz

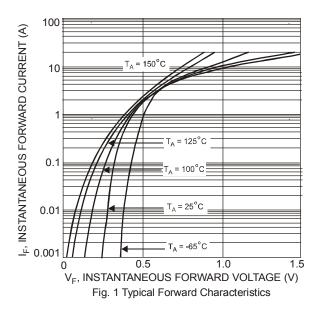
Notes: 6. Theoretical $R_{\theta,JS}$ calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

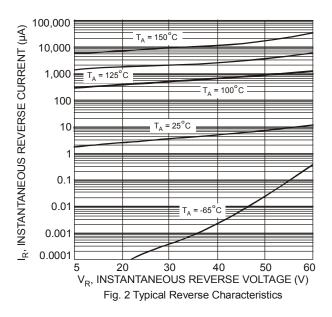
7. Device mounted on Polymide substrate, 1" x 1" 2oz copper double-sided PC board with minimum recommended pad layout, which can be found on our website at http://www.diodes.com.

8. Part mounted on 50.8mm*50.8mm GETEK board with 25.4mm*25.4mm copper pad, 25% anode, 75% cathode. T_A = +25°C

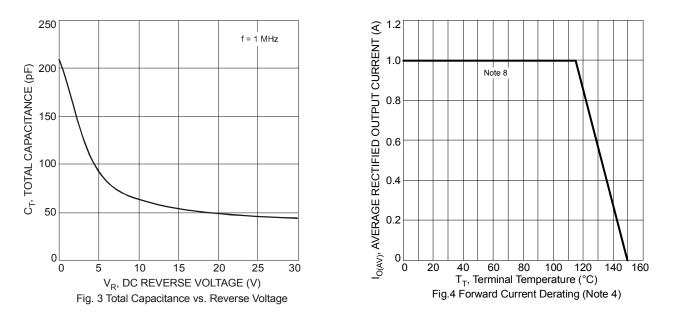
9. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads. TA = +25°C

10. Short duration pulse test to minimize self-heating effect



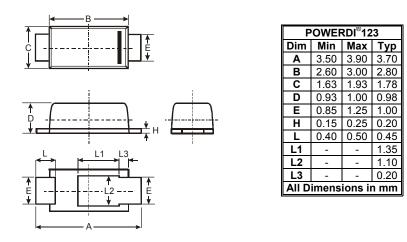






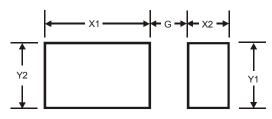
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4



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